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The International Journal of ENGINEERING EDUCATION

AIMS AND SCOPE

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R. Natarajan—The Role of Accreditation in Promoting Quality Assurance of Technical Education

Levy—Engineering Education In The United Kingdom: Standards, Quality Assurance and Accreditation

Bhattacharya—Examining Staged Enhancements for Thermodynamic Cycles to Improve Performance using an Intelligent Instruction Software

Ertugrul—Towards Virtual Laboratories: a Survey of LabVIEW based Teaching/ Learning Tools and Future Trends

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Olanson—Using Virtual Instrumentation to Develop a Modern Biomedical Engineering Laboratory

Lwin—Chemical Equilibrium by Gibbs Energy Minimization on Spreadsheets

Strachan—Introducing Instrumentation and Data Acquisition using LabVIEW

Issa—Quality Assurance of Engineering Education in Private Universities in Jordan

Rubaai—Training of Undergraduate Engineering Students in Sensing and Control Technologies